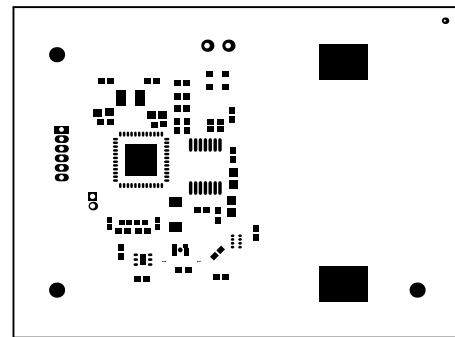
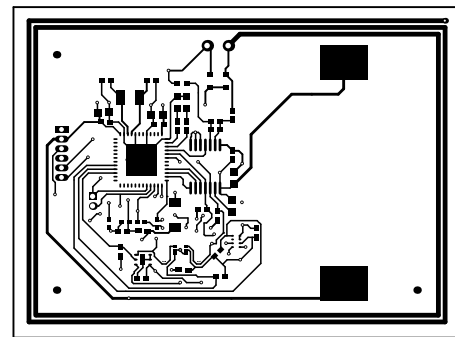


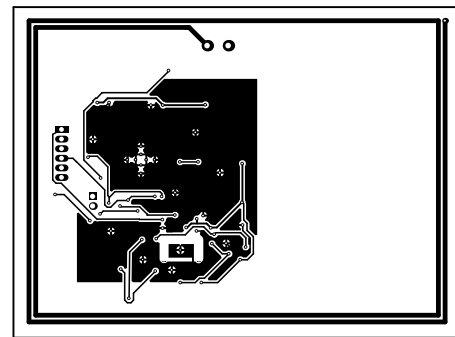
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00524	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00524		
PLOT NAME = Top Overlay	GENERATED : 2/23/2016 4:44:14 PM	TEXAS INSTRUMENTS	



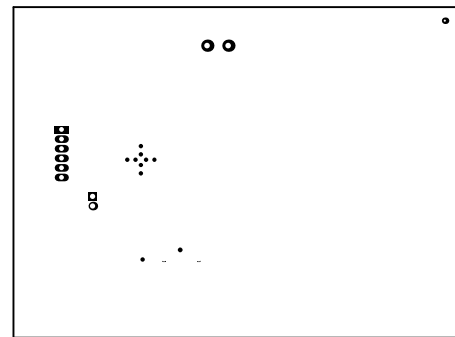
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00524	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00524		
PLOT NAME = Top Solder Mask	GENERATED : 2/23/2016 4:44:16 PM	TEXAS INSTRUMENTS	



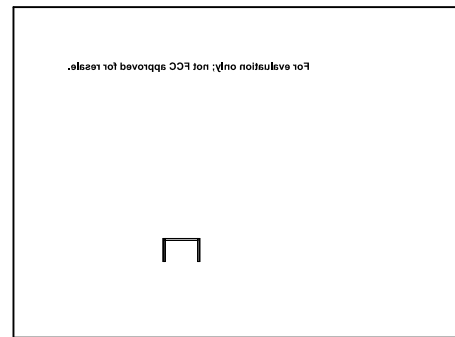
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00524	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00524		
PLOT NAME = Top Layer	GENERATED : 2/23/2016 4:44:18 PM	TEXAS INSTRUMENTS	



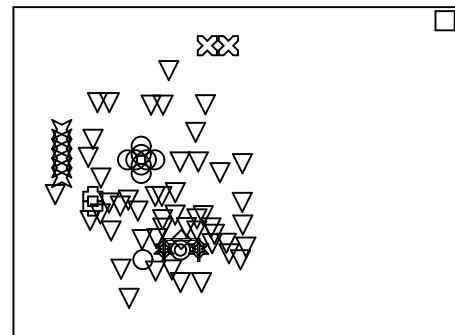
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00524	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00524		
PLOT NAME = Bottom Layer	GENERATED : 2/23/2016 4:44:19 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00524	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00524		
PLOT NAME = Bottom Solder Mask	GENERATED : 2/23/2016 4:44:21 PM	TEXAS INSTRUMENTS	

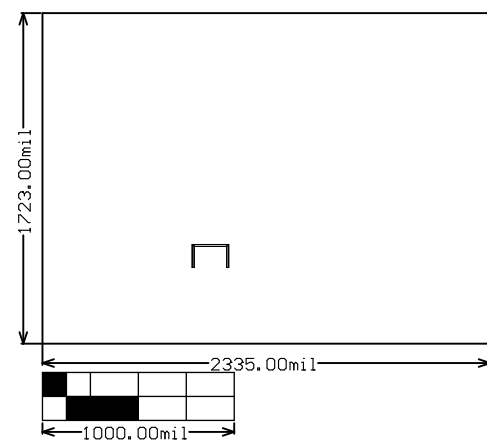


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00524	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00524		
PLOT NAME = Bottom Overlay	GENERATED : 2/23/2016 4:44:22 PM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Finished Hole Size	Plated	Hole Type
●	1	8.00mil (0.203mm)	PTH	Round
□	1	12.00mil (0.305mm)	PTH	Round
◇	1	31.00mil (0.787mm)	NPTH	Slot
⊙	2	28.00mil (0.711mm)	PTH	Round
⊗	2	30.00mil (0.762mm)	PTH	Round
★	2	31.00mil (0.787mm)	NPTH	Slot
⊠	6	26.00mil (0.660mm)	PTH	Round
○	9	7.87mil (0.200mm)	PTH	Round
▽	49	10.00mil (0.254mm)	PTH	Round
73 Total				

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00524	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00524		
PLOT NAME = Drill Drawing	GENERATED : 2/23/2016	4:44:24 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00524	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00524		
PLOT NAME = Board Dimensions	GENERATED : 2/23/2016	4:44:26 PM	TEXAS INSTRUMENTS

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